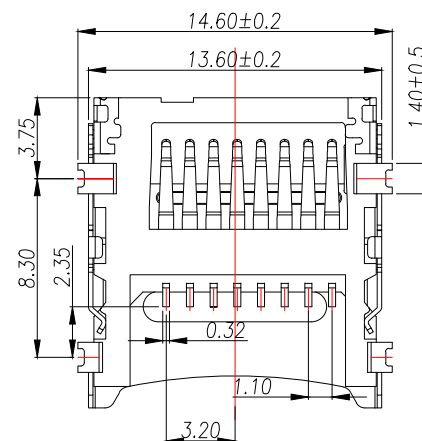
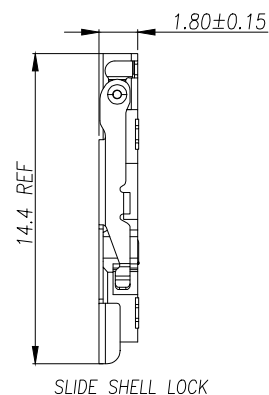
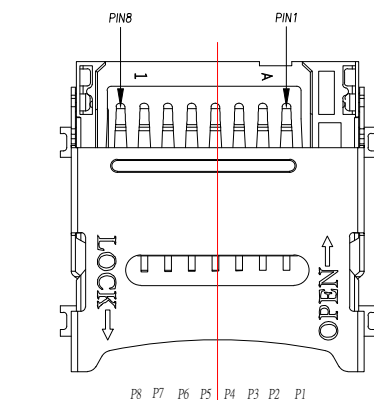


PIN ASSIGNMENT	
P1	DAT2
P2	CD/DAT3
P3	CMD
P4	Vod
P5	CLK
P6	Vss
P7	DAT0
P8	DAT1

MATERIALS

1.HOUSING : HI-TEMP PLASTIC LCP-475

2.TERMINAL: COPPER ALLOY.

PLATING: GOLD PLATED ON CONTACT AREA,
G/F GOLD PLATED ON SOLDER TAILS.

3. SHELL : STAINLESS STEEL.

SPECIFICATION

1. CURRENT RATING : 0.5A MAX.

2. DIELECTRIC WITHSTANDING VOLTAGE :

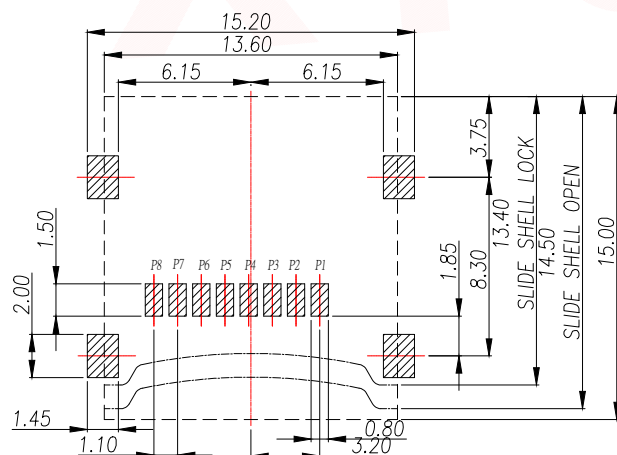
500V AC R.M.S. FOR 1 MINUTE.

3. INSULATION RESISTANCE : 100MΩ MIN.AT 500V DC.

4. CONTACT RESISTANCE : 50mΩ MAX.

SWITCH RESISTANCE : 100mΩ MAX.

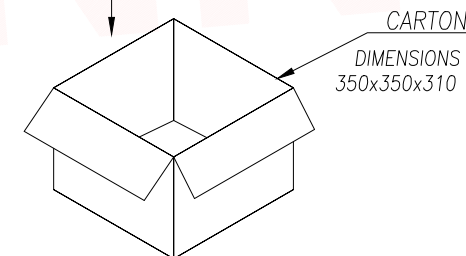
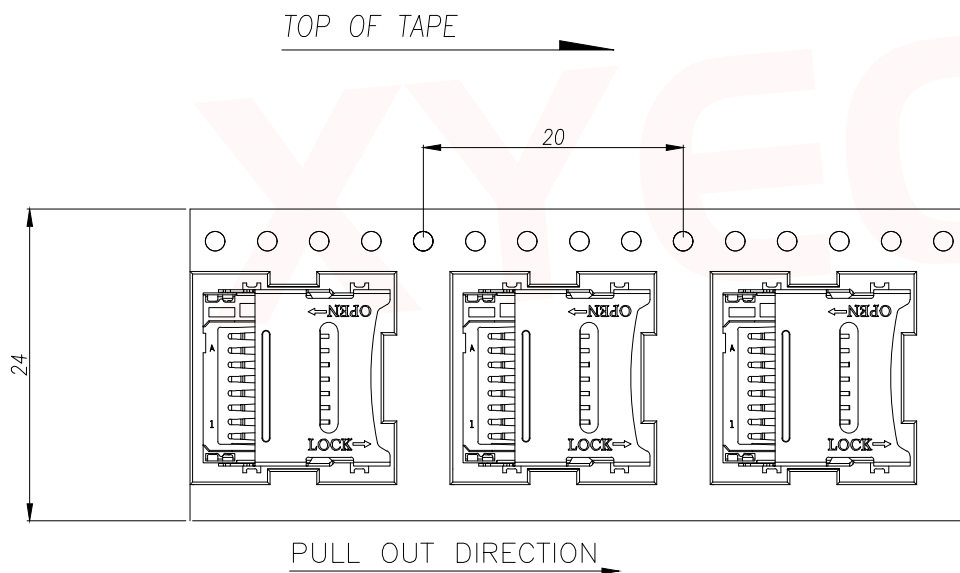
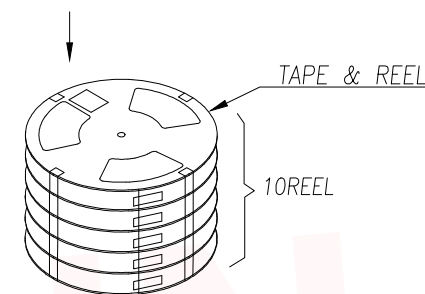
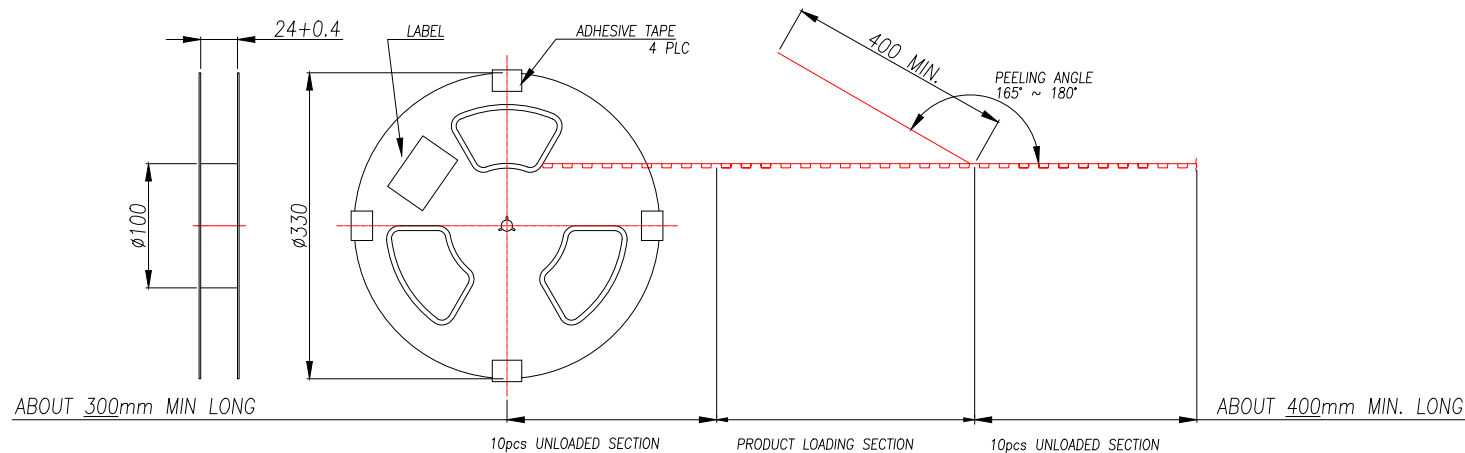
5. OPERATING TEMPERATURE : -30°C TO +85°C.



RECOMMENDED PCB LAYOUT

□ □ □ 产品外形 ▨ 焊盘

DIMENSION IN mm		厦门市辛译精密电子有限公司 Xiamen XinYi Xyconn Electronics Co.,Ltd			
TOLERANCE UNLESS OTHERWISE SPECIFIED					
.X±0.35	X.*± 5°	APR. Alex	TITLE: 1.8H 8PIN HINGE NANO SD CARD CONNECTOR		
.XX±0.25	.X*± 3°	CHK. Jack	DWG NO. TF-04-FWB8AH1.8		
.XXX±0.15	.XX*± 1°	DRA. Can	PROJ. 		CUSTOMER DRAWING
			SIZE A4	SCALE 1:1	SHEET 1/2



NOTES:

1. 20 SPROCKET HOLE PITCH CUMULATIVE TOLERANCE ± 0.2 .
2. MATERIAL: CLARITY CONDUCTIVE POLYSTYRENE ALLOY
100% RECYCLABLE.
3. ALL DIMENSIONS MEET EIA-481-3 REQUIREMENTS.
4. THICKNESS: 0.25 ± 0.05 MM
5. COMPONENT LOAD PER 30.2M" REEL: 1000PCS.
6. 10REEL/CARTON: 10000PCS

DIMENSION IN mm		厦门市辛译精密电子有限公司 Xiamen XinYi Xyeconn Electronics Co.,Ltd				
TOLERANCE UNLESS OTHERWISE SPECIFIED						
.X±0.35	X.*±5°	APR.	Alex	TITLE: 1.8H 8PIN HINGE NANO SD CARD CONNECTOR		
.XX±0.25	.X.*±3°	CHK.	Jack	DWG NO. TF-04-FWB8AH1.8		
.XXX±0.15	.XX.*±1°	DRA.	Can	PROJ. 		CUSTOMER DRAWING
				SIZE A4	SCALE 1:1	SHEET 2/2